

# UNISONIC TECHNOLOGIES CO., LTD

2NM120 **Preliminary** Power MOSFET

# 2.0A, 1200V N-CHANNEL SUPER-JUNCTION MOSFET

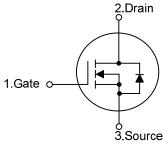
#### **DESCRIPTION**

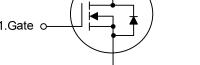
The UTC 2NM120 is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

#### **FEATURES**

- \*  $R_{DS(ON)} \le 6.2 \Omega @ V_{GS} = 10V, I_D = 1.0A$
- \* High Switching Speed



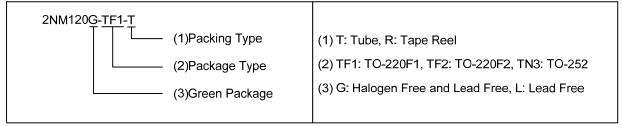




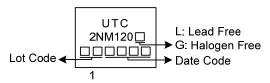
#### **ORDERING INFORMATION**

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
2NM120L-TF1-T	2NM120G-TF1-T	TO-220F1	G	D	S	Tube	
2NM120L-TF2-T	2NM120G-TF2-T	TO-220F2	G	D	S	Tube	
2NM120L-TN3-R	2NM120G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



# **MARKING**



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TO-220F1

TO-220F2

TO-252

# ■ ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	1200	V
Gate-Source Voltage		$V_{GSS}$	±30	V
Continuous Drain Current	Continuous	I <sub>D</sub>	2	Α
	Pulsed	I <sub>DM</sub>	4	Α
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	60	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.5	V/ns
Power Dissipation	TO-220F1 TO-220F2	P <sub>D</sub>	21	W
	TO-252		23	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 100mH,  $I_{AS}$  = 1.09A,  $V_{DD}$  = 50V,  $R_G$  = 25  $\Omega$  Starting  $T_J$  = 25°C
- 4.  $I_{SD} \le 2.0A$ , di/dt $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$

#### **■ THERMAL DATA**

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220F1 TO-220F2	θЈΑ	62.5	°C/W
	TO-252		110	°C/W
Junction to Case	TO-220F1 TO-220F2	θјс	5.95	°C/W
	TO-252		5.43(Note)	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

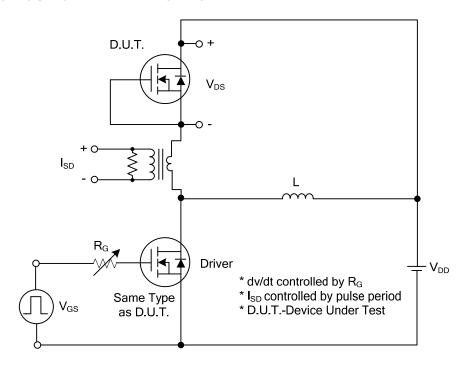
# ■ ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	1200			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =1200V, V <sub>GS</sub> =0V			10	μΑ
Coto Source Leekage Current Forward		$V_{GS}$ =+30V, $V_{DS}$ =0V			+100	nΑ
Gate-Source Leakage Current Reverse	I <sub>GSS</sub>	$V_{GS}$ =-30V, $V_{DS}$ =0V			-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	2.5		4.5	V
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =1.0A			6.2	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C <sub>ISS</sub>			245		pF
Output Capacitance	Coss	$V_{GS}$ =0V, $V_{DS}$ =50V, f=1.0MHz		20		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			2.3		pF
SWITCHING PARAMETERS						
Total Gate Charge	$Q_G$	V <sub>DS</sub> =960V, V <sub>GS</sub> =10V, I <sub>D</sub> =2.0A		16		nC
Gate to Source Charge	$Q_GS$	(Note 1, 2)		6		nC
Gate to Drain Charge	$Q_GD$	(Note 1, 2)		3		nC
Turn-ON Delay Time	t <sub>D(ON)</sub>			5.6		ns
Rise Time	t <sub>R</sub>	$V_{DD}$ =100V, $V_{GS}$ =10V, $I_{D}$ =2.0A,		17		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>	R <sub>G</sub> =25Ω (Note 1, 2)		36		ns
Fall-Time	t <sub>F</sub>			40		ns
SOURCE- DRAIN DIODE RATINGS AND C	HARACTER	ISTICS				
Maximum Body-Diode Continuous Current	Is				2	Α
Maximum Body-Diode Pulsed Current	I <sub>SM</sub>				4	Α
Drain-Source Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> =2.0A, V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>S</sub> =2.0A, V <sub>GS</sub> =0V,		470		ns
Reverse Recovery Charge	Q <sub>rr</sub>	dI <sub>F</sub> /dt=100A/μs (Note 1)		2.9		μC

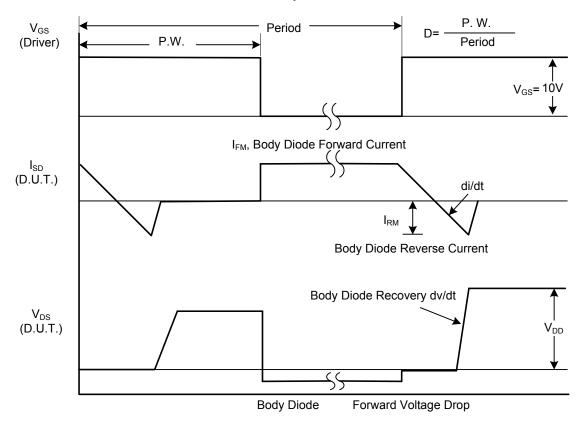
Notes: 1. Pulse Test: Pulse width ≤ 1200µs, Duty cycle ≤ 2%.

<sup>2.</sup> Essentially independent of operating temperature.

#### ■ TEST CIRCUITS AND WAVEFORMS

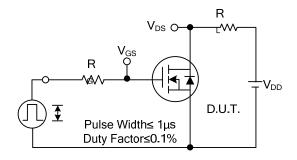


# Peak Diode Recovery dv/dt Test Circuit

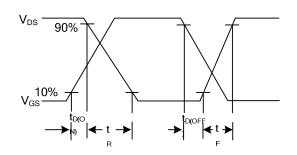


Peak Diode Recovery dv/dt Waveforms

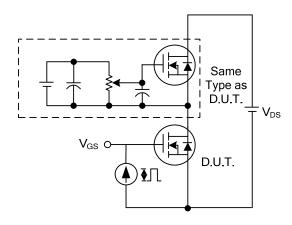
# TEST CIRCUITS AND WAVEFORMS



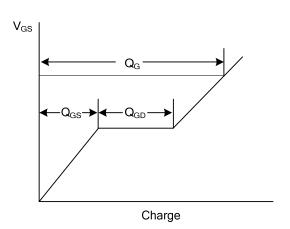
**Switching Test Circuit** 



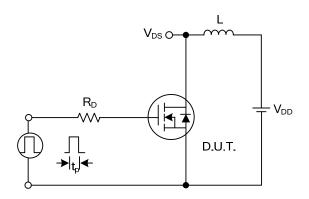
Switching Waveforms



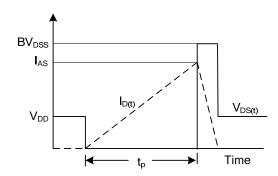
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



**Unclamped Inductive Switching Waveforms** 

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